

**University of California at Berkeley**  
**College of Engineering**  
**Dept. of Electrical Engineering and Computer Sciences**

**EE 105 Midterm I**

Spring 2006

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**Guidelines**

- Closed book and notes.
- One-page information sheet allowed.
- There are some useful formulas in the end of the exam.
- The values of common parameters are listed at the beginning of next page.

**Please use the following parameters for all problems unless specified otherwise:**

$$\phi_{n+} = 550 \text{ mV}, \phi_{p+} = -550 \text{ mV}, V_{th} = 26 \text{ mV}$$

$$\epsilon_{Si} = 11.7, \epsilon_{SiO_2} = 3.9, \epsilon_0 = 8.854 \times 10^{-14} \text{ F/cm},$$

$$q = 1.6 \times 10^{-19} \text{ C}, n_i = 10^{10} \text{ cm}^{-3}.$$

(1) Consider a silicon PN junction diode with an N-doping concentration of  $10^{16} \text{ cm}^{-3}$  and a P-doping concentration of  $10^{18} \text{ cm}^{-3}$ . Their cross-sectional area of the diode is  $100 \mu\text{m}^2$ . Assume the reverse saturation current of the diode is  $10^{-14} \text{ Amp}$ . The diode is forward biased at  $0.7\text{V}$ .

- [10 pt] Find the dynamic resistance at this bias.
- [10 pt] Find the depletion capacitance at this bias.

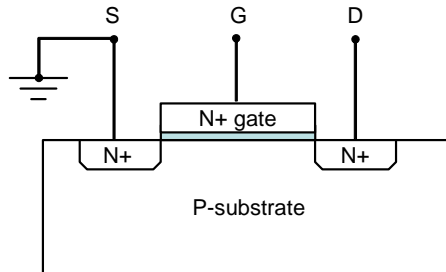
(2) Consider a MOS capacitor with a P+ polysilicon gate and an N-doped substrate with a doping concentration of  $10^{16} \text{ cm}^{-3}$ . The thickness of the oxide is  $20 \text{ nm}$ .

- [10 pt] Find the threshold voltage.
- [10 pt] Which mode is the MOS capacitor in when its gate is biased at  $1 \text{ V}$ ?
- [10 pt] What is the maximum capacitance per unit area?
- [10 pt] What is the minimum capacitance per unit area?

(3) [10 pt] For the MOS capacitor in Problem (2), plot the charge density distribution as a function of position when the gate is biased at  $-2\text{V}$ . Please be as quantitative as possible. Show the positions of all charges, and show the magnitude and polarity of the charges.

(4) [10 pt] If the P+ gate of the MOS capacitor in Problem (2) is replaced by a metal whose electrostatic potential is  $0\text{V}$ . What is the threshold voltage of the new MOS capacitor?

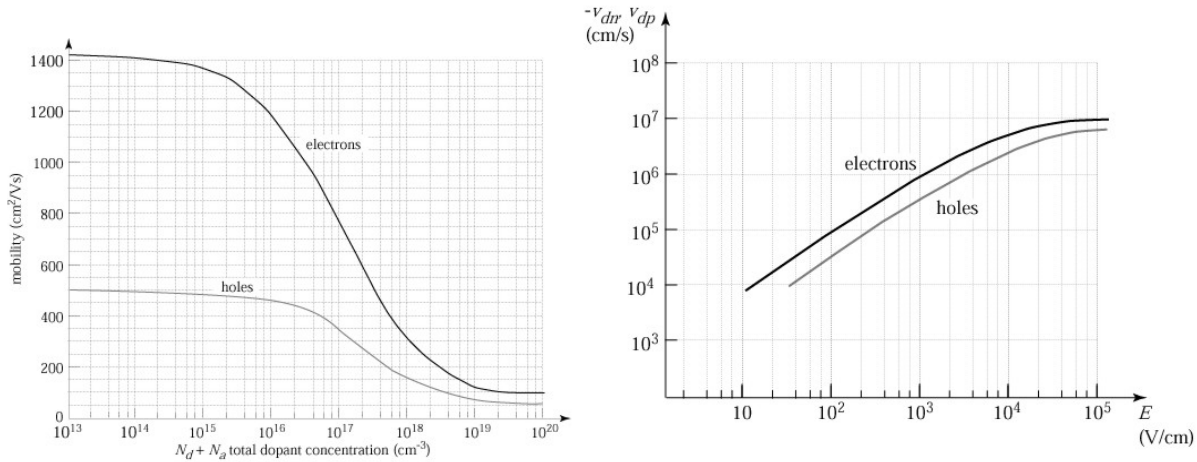
(5) Consider an N-MOSFET with an N+ polysilicon gate on P-type substrate ( $N_a = 10^{17} \text{ cm}^{-3}$ ). The source is grounded, and the drain is biased at  $5\text{V}$ . The transistor has a gate length of  $1 \mu\text{m}$ , and a width of  $10 \mu\text{m}$ . The thickness of gate oxide is  $10 \text{ nm}$ . For simplicity, assume the channel-length modulation parameter  $\lambda = 0$ .



- [10 pt] At what gate voltage does the transistor turn on, i.e., start to have significant current flowing between source and drain?
- [10 pt] Find the drain current when the gate is biased at  $2\text{V}$ .

## Some equations

Mass-action law  $n \times p = n_i^2(T)$



Resistivity:  $\rho_n = \frac{1}{\sigma_n} = \frac{1}{q\mu_n N_{d,eff}}$

Resistance:  $R = \frac{\rho L}{Wt} = \left(\frac{\rho}{t}\right)\left(\frac{L}{W}\right) = R_{sq}\left(\frac{L}{W}\right)$

Total current (e⁻):  $J = J_{drift} + J_{diff} = q\mu_n n E + qD_n \frac{dn}{dx}$

Gauss's law:  $\oint E \cdot dS = \frac{Q}{\epsilon}$        $Q = CV$        $E = -\frac{d\phi}{dx}$

Depletion layer:  $X_{d0} = x_{p0} + x_{n0} = \sqrt{\frac{2\epsilon_s \phi_{bi}}{q} \left(\frac{1}{N_a} + \frac{1}{N_d}\right)}$        $X_d(V_D) = X_{d0} \sqrt{1 - \frac{V_D}{\phi_{bi}}}$

pn depletion layer capacitance:  $C_j = \frac{qN_a x_{p0}}{2\phi_{bi} \sqrt{1 - \frac{V_D}{\phi_{bi}}}} = \frac{C_{j0}}{\sqrt{1 - \frac{V_D}{\phi_{bi}}}}$

pn diffusion current  $J^{diff} = qn_i^2 \left( \frac{D_p}{N_d W_n} + \frac{D_n}{N_a W_p} \right) \left( e^{\frac{qV_D}{kT}} - 1 \right) i_D = I_S \left( e^{\frac{qV_D}{kT}} - 1 \right)$

Diffusion capacitance:  $C_d = \frac{1}{2} \frac{qI_D}{kT} \tau$

Threshold voltage (NMOS)

$$V_{Tn} = V_{FB} - 2\phi_p + \frac{1}{C_{ox}} \sqrt{2q\epsilon_s N_a (-2\phi_p)}$$

$$\phi_p = -\frac{kT}{q} \ln \frac{N_a}{n_i}$$

$$V_{Tn} = V_{Tn0} + \gamma \left( \sqrt{V_{SB} - 2\phi_p} - \sqrt{-2\phi_p} \right)$$

NMOS equations:

$$I_D = 0, \quad V_{GS} < V_{Tn}$$

$$i_D = \frac{W}{L} \mu C_{ox} \left( V_{GS} - V_{Tn} - \frac{V_{DS}}{2} \right) V_{DS} (1 + \lambda V_{DS}), \quad V_{GS} > V_{Tn}, \quad V_{DS} < V_{GS} - V_{Tn}$$

$$i_D = \frac{W}{L} \frac{\mu C_{ox}}{2} (V_{GS} - V_{Tn})^2 (1 + \lambda V_{DS}), \quad V_{GS} > V_{Tn}, \quad V_{DS} > V_{GS} - V_{Tn}$$

MOS capacitances in saturation  $C_{gs} = (2/3)WLC_{ox} + C_{ov}$   $C_{ov} = L_D W C_{ox}$

MOS signal parameters:

$$g_m = \left. \frac{\partial i_D}{\partial V_{GS}} \right|_{V_{GS}, V_{DS}} = \mu C_{ox} \frac{W}{L} (V_{GS} - V_{Tn}) (1 + \lambda V_{DS}) \approx \mu C_{ox} \frac{W}{L} (V_{GS} - V_{Tn})$$

$$r_o = \left( \left. \frac{\partial i_D}{\partial V_{DS}} \right|_{V_{GS}, V_{DS}} \right)^{-1} \approx \frac{1}{\lambda I_{DS}}$$

$$g_{mb} = \left. \frac{\partial i_D}{\partial V_{BS}} \right|_Q = \frac{\gamma g_m}{2\sqrt{-V_{BS} - 2\phi_p}}$$

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$$\begin{aligned}
 q &:= 1.6 \cdot 10^{-19} & n_i &:= 10^{10} & V_{th} &:= 0.026 \\
 \epsilon_0 &:= 8.854 \cdot 10^{-14} & \epsilon_s &:= 11.7 \cdot \epsilon_0 & \epsilon_{ox} &:= 3.9 \cdot \epsilon_0 \\
 \mu_m &:= 10^{-4} & nm &:= 10^{-7} & mV &:= 10^{-3} \\
 \mu_n &:= 1450 \text{ cm}^2/\text{V}\cdot\text{sec}
 \end{aligned}$$

(1) (a)  $I_s := 10^{-14}$

$$I_d(V_d) := I_s \cdot \left( \exp\left(\frac{V_d}{V_{th}}\right) - 1 \right)$$

$$I_d(0.7) = 4.927 \times 10^{-3}$$

$$r_{d} := \frac{V_{th}}{I_d(0.7)} \quad r_{d} = 5.278 \text{ } \Omega$$

(b)  $N_d := 10^{16}$        $N_a := 10^{18}$        $Area := 100 \cdot \mu\text{m}^2$

$$\phi_n := 60 \cdot \text{mV} \cdot \log\left(\frac{N_d}{n_i}\right) \quad \phi_n = 0.36$$

$$\phi_p := -60 \cdot \text{mV} \cdot \log\left(\frac{N_a}{n_i}\right) \quad \phi_p = -0.48$$

$$\phi_b := \phi_n - \phi_p \quad \phi_b = 0.84$$

$$x_d(V_d) := \sqrt{\frac{2 \cdot \epsilon_s \cdot (\phi_b - V_d)}{q} \cdot \left(\frac{1}{N_a} + \frac{1}{N_d}\right)} \quad x_d(0.7) = 1.353 \times 10^{-5}$$

$$C_j := \frac{\epsilon_s}{x_d(0.7)} \cdot Area \quad C_j = 7.656 \times 10^{-14} \text{ F}$$

(2)  $N_d := 10^{16}$        $tox := 20 \cdot \text{nm}$

$$\phi_n := 60 \cdot \text{mV} \cdot \log\left(\frac{N_d}{n_i}\right) \quad \phi_n = 0.36$$

$$\phi_{pp} := -550 \cdot \text{mV}$$

$$V_{FB} := \phi_n - \phi_{pp} \quad V_{FB} = 0.91 \text{ V}$$

(a)  $X_{d\_max} := \sqrt{\frac{2 \cdot \epsilon_s \cdot (2 \cdot \phi_n)}{q \cdot N_d}} \quad X_{d\_max} = 3.053 \times 10^{-5}$

$$Q_{b\_max} := q \cdot N_d \cdot X_{d\_max}$$

$$C_{ox} := \frac{\epsilon_{ox}}{tox}$$

$$V_{Tp} := V_{FB} - 2 \cdot \phi_n - \frac{Q_{b\_max}}{C_{ox}} \quad V_{Tp} = -0.093$$

(b) 1V is greater than flatband voltage --> the MOS is in accumulation mode

(c) Maximum capacitance is simply Cox:

$$C_{\max} := C_{ox} \quad C_{\max} = 1.727 \times 10^{-7} \text{ F/cm}^2$$

$$(d) \quad C_{b\_min} := \frac{\epsilon s}{X_{d\_max}}$$

$$C_{min} := \frac{C_{ox} \cdot C_{b\_min}}{C_{ox} + C_{b\_min}} \quad C_{min} = 2.835 \times 10^{-8} \text{ F/cm}^2$$

(3) -2V is more negative than threshold (-0.093V), so it is in inversion. The charge on the semiconductor side include a fixed donor charges from the semiconductor-oxide interface to the maximum depletion width,  $X_{d\_max}$  and the inversion hole charges at the interface,  $Q_p$ . The gate charge is equal to the total charge with opposite sign.

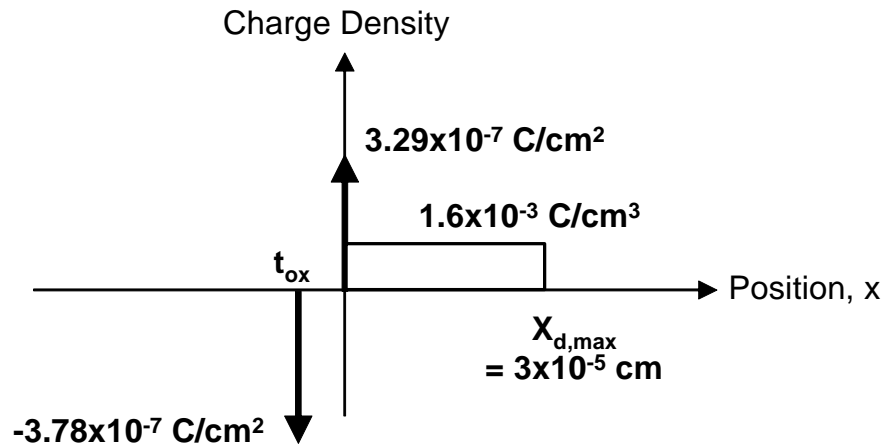
$$V_{GB} := -2$$

$$Q_p := -C_{ox} \cdot (V_{GB} - V_{Tp}) \quad Q_p = 3.293 \times 10^{-7} \text{ C/cm}^2$$

$$\rho_b := q \cdot N_d \quad \rho_b = 1.6 \times 10^{-3} \text{ C/cm}^3$$

$$Q_g := -Q_p - \rho_b \cdot X_{d\_max} \quad Q_g = -3.781 \times 10^{-7} \text{ C/cm}^2$$

$$X_{d\_max} = 3.053 \times 10^{-5} \text{ cm}$$



(4) Flatband voltage and threshold voltage is shifted by the same amount:

$$\phi_m := 0$$

$$V_{FB\_m} := \phi_n - \phi_m \quad V_{FB\_m} = 0.36$$

$$\Delta V_{FB} := V_{FB\_m} - V_{FB} \quad \Delta V_{FB} = -0.55$$

$$V_{Tp\_m} := V_{Tp} + \Delta V_{FB} \quad V_{Tp\_m} = -0.643 \text{ V}$$

$$(5) \quad N_a := 10^{17} \quad t_{ox} := 10 \cdot \text{nm} \quad W := 10 \cdot \mu\text{m} \quad L := 1 \cdot \mu\text{m}$$

$$\phi_p := -60 \cdot \text{mV} \cdot \log\left(\frac{N_a}{n_i}\right) \quad \phi_p = -0.42$$

$$\phi_{nn} := 550 \cdot \text{mV}$$

$$V_{FB} := \phi_p - \phi_{nn} \quad V_{FB} = -0.97$$

$$X_{d\_max} := \sqrt{\frac{2 \cdot \epsilon_s \cdot (-2 \cdot \phi_p)}{q \cdot N_a}} \quad X_{d\_max} = 1.043 \times 10^{-5}$$

$$Q_{b\_max} := -q \cdot N_a \cdot X_{d\_max}$$

$$C_{ox} := \frac{\epsilon_{ox}}{t_{ox}}$$

$$V_{Tn} := V_{FB} - 2 \cdot \phi_p - \frac{Q_{b\_max}}{C_{ox}} \quad V_{Tn} = 0.353$$

(a) The NMOS FET is turned on when the gate voltage is equal to the threshold voltage

$$V_{Tn} = 0.353$$

(b)  $V_{GS} := 2$

$$V_{DS} := 5$$

$$V_{DS\_sat} := V_{GS} - V_{Tn} \quad V_{DS\_sat} = 1.647$$

Since  $V_{DS}$  is greater than  $V_{DS\_sat}$ , the FET is in saturation

$$I_{DS}(V) := \frac{W}{L} \cdot \frac{\mu_n \cdot C_{ox}}{2} \cdot (V_{GS} - V_{Tn})^2 \quad I_{DS}(5) = 6.789 \times 10^{-3} \text{ Amp}$$